CZSH6-100C

SURFACE MOUNT SILICON DUAL, COMMON CATHODE SCHOTTKY POWER RECTIFIER 6.0 AMP, 100 VOLT



www.centralsemi.com

DESCRIPTION:

The CENTRAL SEMICONDUCTOR CZSH6-100C is manufactured with two 3.0 Amp Schottky rectifiers assembled in a common cathode configuration and packaged in a SOT-223 case. This device has been designed for high voltage applications requiring a low forward voltage drop.

MARKING: FULL PART NUMBER



SOT-223 CASE

MAXIMUM RATINGS: (T_A=25°C unless otherwise noted)

	SYMBOL		UNITS
Peak Repetitive Reverse Voltage	V_{RRM}	100	V
DC Blocking Voltage	V_{R}	100	V
RMS Reverse Voltage	V _{R(RMS)}	70	V
Average Forward Current (T _A =75°C)	IO	6.0	Α
Peak Forward Surge Current, tp=8.3ms	I _{FSM}	75	Α
Operating and Storage Junction Temperature	$T_{J_{i}}T_{stg}$	-65 to +150	°C
Thermal Resistance	Θ_{JA}	62.5	°C/W

ELECTRICAL CHARACTERISTICS PER DIODE:	(T	A=25°C unless otherwise noted)
--	----	--------------------------------

SYMBOL	TEST CONDITIONS	MAX	UNITS
I_{R}	V _R =100V	10	μΑ
I_{R}	V _R =100V, T _A =100°C	20	mA
V_{F}	I _F =1.0A	0.7	V
V_{F}	I _F =3.0A	0.8	V
V_{F}	I _F =6.0A	1.0	V

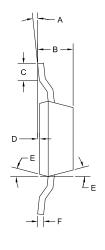
R3 (7-May 2019)

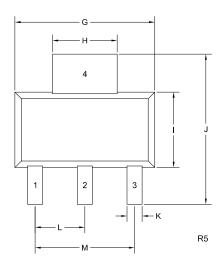
CZSH6-100C

SURFACE MOUNT SILICON DUAL, COMMON CATHODE SCHOTTKY POWER RECTIFIER 6.0 AMP, 100 VOLT



SOT-223 CASE - MECHANICAL OUTLINE

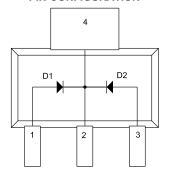




DIMENSIONS							
	INCHES		MILLIMETERS				
SYMBOL	MIN	MAX	MIN	MAX			
Α	0°	10°	0°	10°			
В	0.059	0.071	1.50	1.80			
С	0.018		0.45				
D	0.000	0.004	0.00	0.10			
Е	10°		10°				
F	0.009	0.014	0.23	0.35			
G	0.248	0.270	6.30	6.85			
Н	0.114	0.122	2.90	3.10			
- 1	0.130	0.146	3.30	3.70			
J	0.264	0.287	6.70	7.30			
K	0.024	0.033	0.60	0.85			
L	0.091		2.30				
М	0.181		4.60				

SOT-223 (REV: R5)

PIN CONFIGURATION



LEAD CODE:

- 1) Anode D1
- 2) Cathode D1, D2
- 3) Anode D2
- 4) Cathode D1, D2

Pin 2 and Pin 4 are common.

MARKING:

FULL PART NUMBER

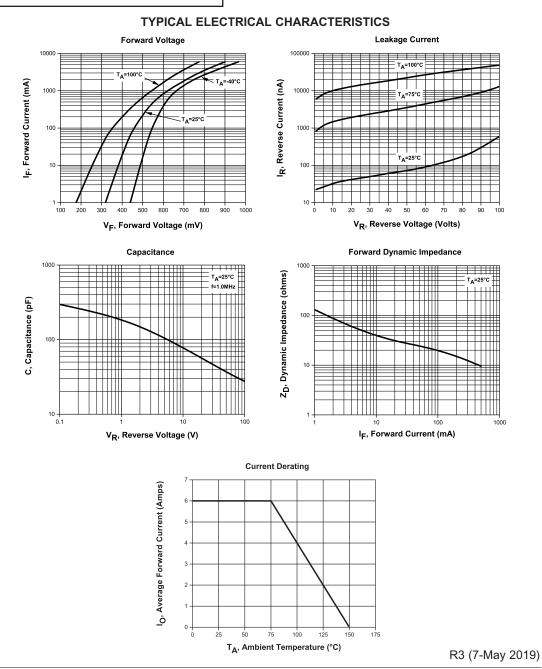
R3 (7-May 2019)

www.centralsemi.com

CZSH6-100C

SURFACE MOUNT SILICON DUAL, COMMON CATHODE SCHOTTKY POWER RECTIFIER 6.0 AMP, 100 VOLT





www.centralsemi.com



OUTSTANDING SUPPORT AND SUPERIOR SERVICES

PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- · Inventory bonding
- · Consolidated shipping options

- Custom bar coding for shipments
- · Custom product packing

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free quick ship samples (2nd day air)
- · Online technical data and parametric search
- SPICE models
- · Custom electrical curves
- · Environmental regulation compliance
- · Customer specific screening
- · Up-screening capabilities

- Special wafer diffusions
- · PbSn plating options
- · Package details
- · Application notes
- · Application and design sample kits
- Custom product and package development

REQUESTING PRODUCT PLATING

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

Corporate Headquarters & Customer Support Team

Central Semiconductor Corp. 145 Adams Avenue Hauppauge, NY 11788 USA Main Tel: (631) 435-1110 Main Fax: (631) 435-1824

Support Team Fax: (631) 435-3388

www.centralsemi.com

Worldwide Field Representatives: www.centralsemi.com/wwreps

Worldwide Distributors:

www.centralsemi.com/wwdistributors

For the latest version of Central Semiconductor's **LIMITATIONS AND DAMAGES DISCLAIMER**, which is part of Central's Standard Terms and Conditions of sale, visit: www.centralsemi.com/terms

www.centralsemi.com (001)